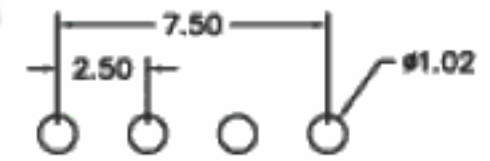
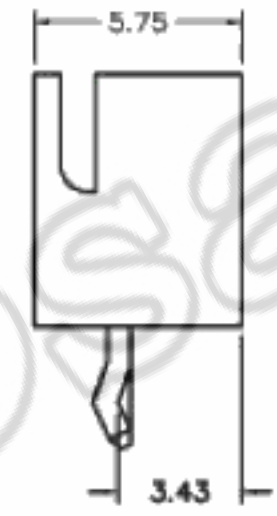
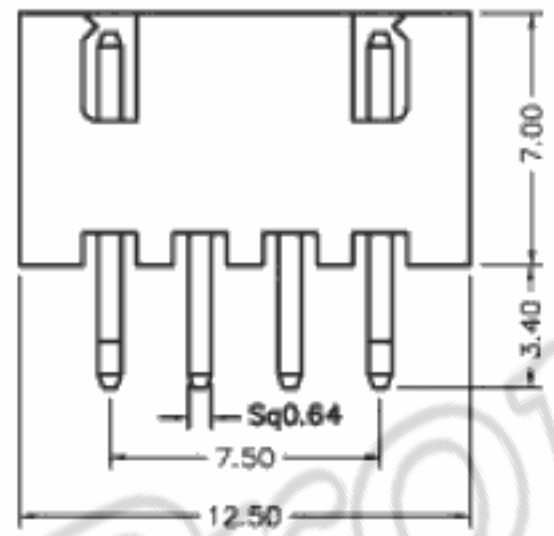
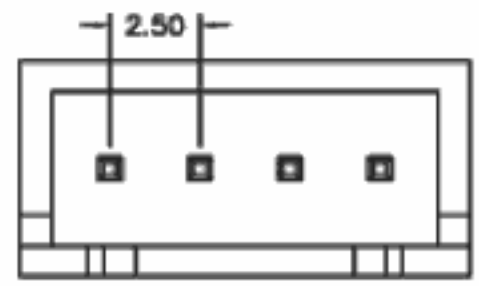


REV	ECN.NO:	BY	DATE
A0	NEW DWG	-	10.06.08

NOTES:

1. MATERIAL:
  - 1.1 HOUSING: THERMOPLASTIC, UL94 V-0; COLOR: BLACK
  - 1.2 CONTACT: BRASS
2. SPECIFICATION:
  - 2.1 CURRENT RATE: 2AMP
  - 2.2 DIELECTRIC VOLTAGE: 800V AC FOR ONE MINUTE
  - 2.3 INSULATION RESISTANCE: 1000M OHMS MIN
  - 2.4 CONTACT RESISTANCE: 20MILLI OHMS MAX
3. FINISH:
  - 2.1 CONTACT: TIN PLATING OVERALL
- 4 RECOMMENDED P.C.B THICKNESS : 1.6mm
5. OTHER GENERAL SPEC. TO REFER : HEADER SERIES SPEC.
6. FOR WAVE SOLDERING LEAD-FREE PROCESS
7. PART NO. : 21B104-0120-7 5 R

- R: RoHS
- MATERIAL: 5 HOUSING: PA66,COLOR: WHITE
- PLATING: 7. CONTACT: Tin PLATED;



Recommended P.C.Board layout

CUSTOMER DRAWING		<b>LITE</b> Liteconn Co.,Ltd.	
-TOLERANCES- UNLESS OTHERWISE SPECIFIED		TITLE: 2.50MM HEADER 1*4P 180度 DIP 引脚	
X.X ±0.35	X.X' ±3'	APPD: Anderson.Chiu	DWG NO: 21B104-0120-75R
X.XX ±0.25	X.XX' ±2'	CHECK: Bill.Chen	DATE
X.XXX ±0.15	X.XXX' ±1'	DRAW: Jacky.Lv	SCALE
			UNIT
			PAGE
		2010.06.08	1:1
			MM
			1/1

COMPLIANCE WITH THE REQUIREMENT  RoHS  HP  SONY00259  OTHER  
 \*\* NO USING RESTRICTED AND BANNED SUBSTANCE